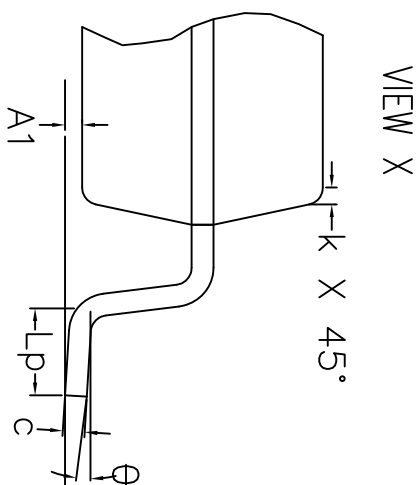
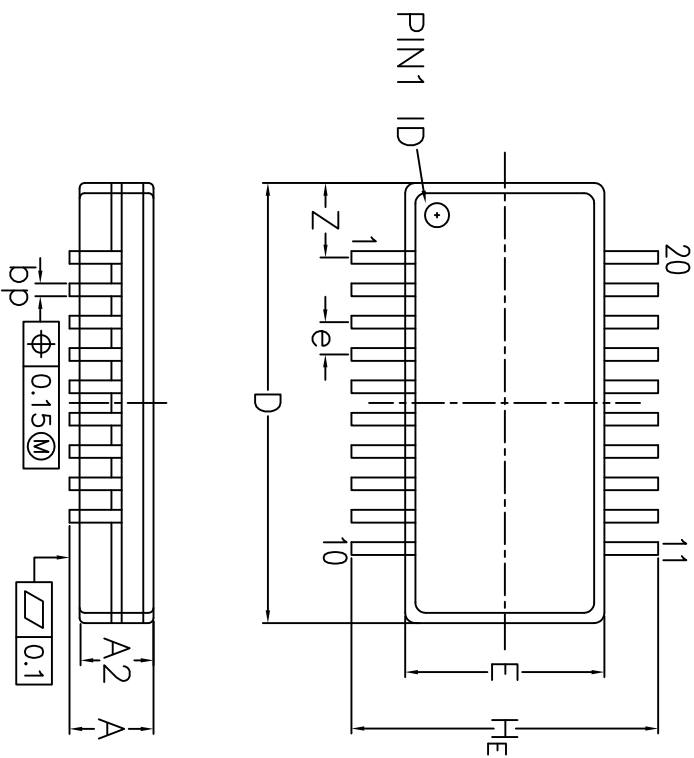


REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	2/29/16	J.H



DIMENSIONS OF SUB-GROUP B1	
A max	1.73
bp min	0.20
bp max	0.30
e nom	0.635
He min	5.84
He max	6.20
Lpmin	0.41
Z max	1.5

DIMENSIONS OF SUB-GROUP C1	
A min	1.54
A1 min	0.10
A1 max	0.25
A2 min	1.40
A2 max	1.55
c min	0.18
c max	0.25
D min*	8.55
D max*	8.73
E min*	3.82
E max*	4.00
k min	0.25
θ max	0°
θ max	10°

2. WEIGHT ≤ 0.4 g
3. BODY MATERIAL LOW STRESS EPOXY
4. LEAD MATERIAL Cu-ALLOY
5. LEAD FINISH SOLDER PLATING
6. LEAD FORM Z-BENDS

\* WITHOUT MOLD FLASH

TOLERANCES UNLESS SPECIFIED			
DECIMAL	±	8024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 284-8200 FAX: (408) 284-3572	
ANGULAR	±	www.IDT.com	
APPROVALS	DATE	TITLE	KAG20 PACKAGE OUTLINE 3.9mm S5OP
DRAWN	DATE	SIZE	DRAWING No. PSC-4655 DO NOT SCALE DRAWING
CHECKED		REV	00
		SHEET 1 OF 1	